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***IN THE UNITED STATES PATENT AND TRADEMARK OFFICE***

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In re application of: Nikhil Vishwanath Kelkar

Attorney Docket No.: NSC1P300/P05882

Application No.: 10/824,903

Examiner: Zarneke, David A.

Filed: April 14, 2004

Group: 2891

Title: WAFER LEVEL PACKAGE DESIGN  
THAT FACILITATES TRIMMING AND  
TESTING

Confirmation No: 7593

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**AMENDMENT B**

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In response to the Final Office Action mailed October 2, 2006, please amend the above-identified patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims, which begin on page 2 of this paper.

**Remarks/Arguments** begin on page 5 of this paper.